



PRODUCT SPECIFICATION

CDTECH Model: **S032BQ24EN**

CUSTOMER Model: **-**

Description: **3.2 " TFT-LCD Module**

Version: **1.0**

CDTECH	PREPARED BY	CHECKED BY	APPROVED BY
SIGNATURE			
DATE	2024.3.16	2024.3.16	2024.3.16

CUSTOMER APPROVAL	SIGNATURE	DATE



Contents

1. General Specifications	4
2. Absolute Maximum Ratings	4
3. Electrical Characteristics	5
4. Interface Pin Assignment	6
5. Interface Characteristics	7
6. Optical Specifications	13
7. Reliability Test Items	17
8. Mechanical Drawing	18
9. Packing	19
10. Precautions for Use of LCD modules	20

1. General Specifications

1.1 LCM General Information

Item	Specification	Unit
LCD Size	3.2	inch
Number of Pixels	240 (H) RGB x 320 (V)	pixels
Display Mode	Normally Black	-
Viewing Direction	Free	o' clock
Interface	MCU	-
Display Colors	262K	colors
Outline Dimension	52.60 (H) x 72.20 (V) x 3.50 (D)	mm
Active Area	48.60 (H) x 64.80 (V)	mm
Pixel Pitch	0.2025 (H) x 0.2025 (V)	mm
Driver IC	ST7789T3	-
Operation Temperature	-20~70	°C
Storage Temperature	-30~80	°C

Note1:Requirements on environmental protection RoHS compliant.

2. Absolute Maximum Ratings

Item	Symbol	MIN.	MAX.	Unit	Note
Analog Supply voltage	VCI	-0.3	5.0	V	Note 1
Digital supply voltage	VDDI	-0.3	3.6	V	Note 1

Note 1:Permanent damage may occur to the LCD module if beyond this specification.

Functional operation should be restricted to the conditions described under normal operating conditions.

3. Electrical Characteristics

3.1 Recommended Operating Condition for TFT LCD

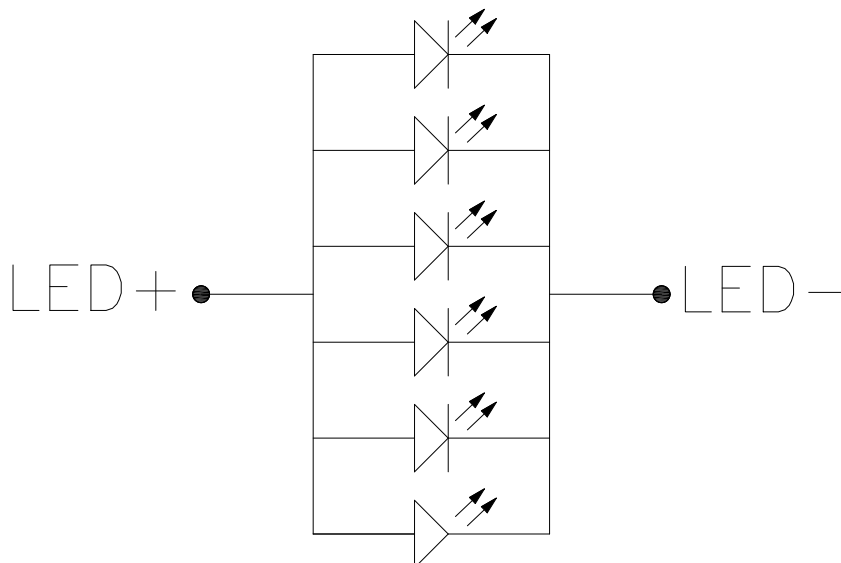
Item	Symbol	Min.	Typ.	Max.	Unit	Note
Analog Supply voltage	V _{CI}	2.5	2.8	3.3	V	
Analog supply current	I _{VCI}	-	TBD	-	mA	V _{CI} =2.8V
Logic supply voltage	V _{DDI}	1.65	1.8	3.3	V	
Logic supply current	I _{VDDI}	-	TBD	-	mA	V _{DDI} =1.8V
Logic input voltage	V _{IH}	0.7*V _{DDI}	-	V _{DDI}	V	
	V _{IL}	GND	-	0.3*V _{DDI}	V	

3.2 Recommended Driving Condition for Backlight

Item	Symbol	Min.	Typ.	Max.	Unit	Note
Driving Current	I _F	-	120	-	mA	
Driving Voltage	V _F	2.7	-	3.3	V	
Power consumption	W _{BL}	0.324	-	0.396	W	
LED Life-Time	N/A	30,000	-	-	Hours	Ta=25°C Note 1

Note 1: LED lifetime is defined as the module brightness decay 50% of original brightness at Ta=25 degree, typical current.

Note 2: LED circuit :



4. Interface Pin Assignment

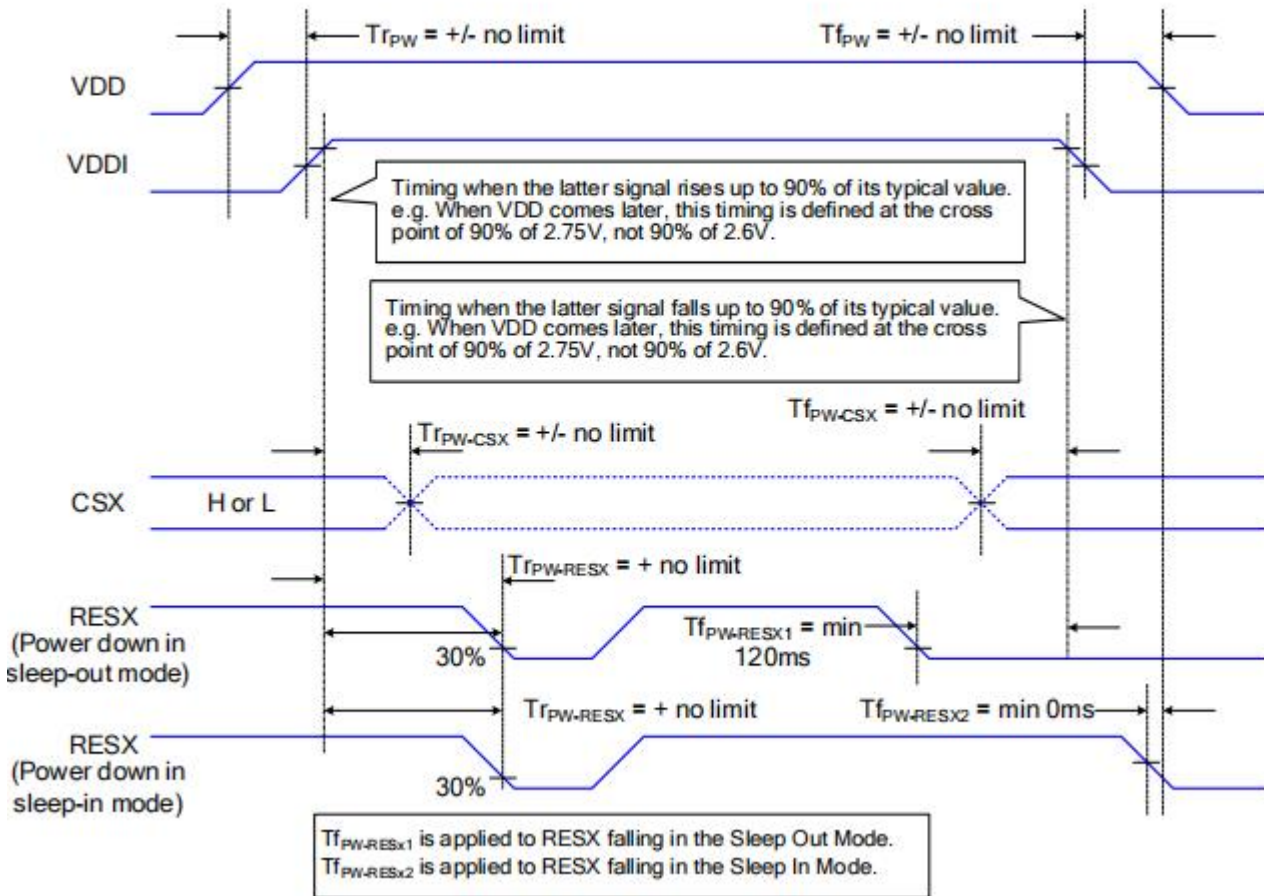
4.1 LCM Pin Assignment

No.	Symbol	Description																																																																																						
1	LED+A	Power for LED backlight (Anode)																																																																																						
2	LED-K	Power for LED backlight (Cathode)																																																																																						
3	GND	Ground																																																																																						
4	VCI	Power supply																																																																																						
5	VDDI	Power Supply																																																																																						
6	GND	Ground																																																																																						
7	RESET	Global reset pin																																																																																						
8	IM0	<p>The MCU interface mode select</p> <table border="1"> <thead> <tr> <th>IM3</th> <th>IM2</th> <th>IM1</th> <th>IM0</th> <th>MCU Interface Mode</th> <th>Data pin</th> </tr> </thead> <tbody> <tr> <td>0</td> <td>0</td> <td>0</td> <td>0</td> <td>80-8bit parallel I/F</td> <td>DB[7:0]</td> </tr> <tr> <td>0</td> <td>0</td> <td>0</td> <td>1</td> <td>80-16bit parallel I/F</td> <td>DB[15:0]</td> </tr> <tr> <td>0</td> <td>0</td> <td>1</td> <td>0</td> <td>80-9bit parallel I/F</td> <td>DB[8:0]</td> </tr> <tr> <td>0</td> <td>0</td> <td>1</td> <td>1</td> <td>80-18bit parallel I/F</td> <td>DB[17:0]</td> </tr> <tr> <td rowspan="2">9</td> <td rowspan="2">IM1</td> <td rowspan="2">0</td> <td rowspan="2">1</td> <td>3-line 9bit serial I/F</td> <td>SDA: in/out</td> </tr> <tr> <td>2 data lane serial I/F</td> <td>SDA: in/out WRX: in</td> </tr> <tr> <td rowspan="3">10</td> <td rowspan="3">IM2</td> <td rowspan="3">0</td> <td rowspan="3">1</td> <td rowspan="3">1</td> <td rowspan="3">0</td> <td>4-line 8bit serial I/F</td> <td>SDA: in/out</td> </tr> <tr> <td>1</td> <td>0</td> <td>0</td> <td>0</td> <td>80-16bit parallel I/F II</td> <td>DB[17:10], DB[8:1]</td> </tr> <tr> <td>1</td> <td>0</td> <td>0</td> <td>1</td> <td>80-8bit parallel I/F II</td> <td>DB[17:10]</td> </tr> <tr> <td rowspan="3">11</td> <td rowspan="3">IM3</td> <td rowspan="3">1</td> <td rowspan="3">0</td> <td rowspan="3">1</td> <td rowspan="3">1</td> <td>80-18bit parallel I/F II</td> <td>DB[17:0]</td> </tr> <tr> <td>1</td> <td>0</td> <td>1</td> <td>1</td> <td>80-9bit parallel I/F II</td> <td>DB[17:9]</td> </tr> <tr> <td>1</td> <td>1</td> <td>0</td> <td>1</td> <td>3-line 9bit serial I/F II</td> <td>SDA: in/ SDO: out</td> </tr> <tr> <td></td> <td></td> <td>1</td> <td>1</td> <td>1</td> <td>0</td> <td>4-line 8bit serial I/F II</td> <td>SDA:in/ SDO: out</td> </tr> </tbody> </table>	IM3	IM2	IM1	IM0	MCU Interface Mode	Data pin	0	0	0	0	80-8bit parallel I/F	DB[7:0]	0	0	0	1	80-16bit parallel I/F	DB[15:0]	0	0	1	0	80-9bit parallel I/F	DB[8:0]	0	0	1	1	80-18bit parallel I/F	DB[17:0]	9	IM1	0	1	3-line 9bit serial I/F	SDA: in/out	2 data lane serial I/F	SDA: in/out WRX: in	10	IM2	0	1	1	0	4-line 8bit serial I/F	SDA: in/out	1	0	0	0	80-16bit parallel I/F II	DB[17:10], DB[8:1]	1	0	0	1	80-8bit parallel I/F II	DB[17:10]	11	IM3	1	0	1	1	80-18bit parallel I/F II	DB[17:0]	1	0	1	1	80-9bit parallel I/F II	DB[17:9]	1	1	0	1	3-line 9bit serial I/F II	SDA: in/ SDO: out			1	1	1	0	4-line 8bit serial I/F II	SDA:in/ SDO: out
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12	CSX		Chip select input signal																																																																																					
13	WRX	Write enable in MCU parallel interface																																																																																						
14	RDX	Read enable in 8080 MCU parallel interface																																																																																						
15	DCX/SCL	Serial clock signal																																																																																						
16	SDA	Serial data input/output signal																																																																																						
17	SDO	Serial data output																																																																																						
18-35	DB0-DB17	DB0-DB17 are used as MCU parallel interface data bus																																																																																						
36	GND	Ground																																																																																						
37	YU (NC)	No connection																																																																																						
38	XL (NC)	No connection																																																																																						
39	YD (NC)	No connection																																																																																						
40	XR (NC)	No connection																																																																																						

5. Interface Characteristics

5.1 Power ON/OFF Sequence

The power on/off sequence is illustrated below



5.2 AC Characteristics

8080 Series MCU Parallel Interface Characteristics: 18/16/9/8-bit Bus

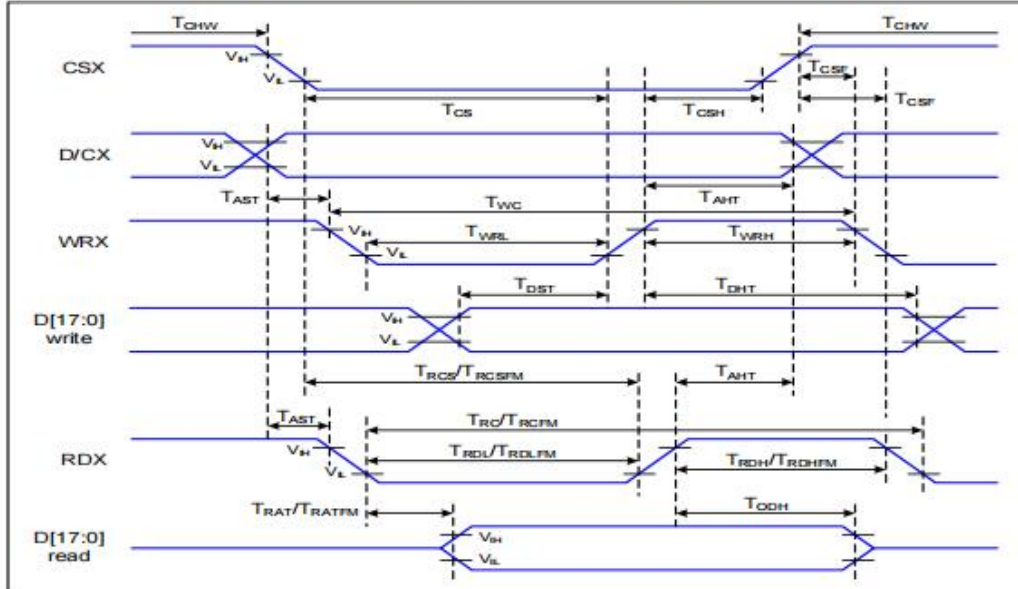


Figure 1 Parallel Interface Timing Characteristics (8080-Series MCU Interface)

VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta=25°C

Signal	Symbol	Parameter	Min	Max	Unit	Description
D/CX	T _{AST}	Address setup time	0		ns	-
	T _{AHT}	Address hold time (Write/Read)	10		ns	
CSX	T _{CHW}	Chip select "H" pulse width	0		ns	-
	T _{CS}	Chip select setup time (Write)	15		ns	
	T _{RC}	Chip select setup time (Read ID)	45		ns	
	T _{RC_{SFM}}	Chip select setup time (Read FM)	355		ns	
	T _{CSF}	Chip select wait time (Write/Read)	10		ns	
	T _{CSH}	Chip select hold time	10		ns	
WRX	T _{WC}	Write cycle	66		ns	-
	T _{WRH}	Control pulse "H" duration	15		ns	
	T _{WRL}	Control pulse "L" duration	15		ns	
RDX (ID)	T _{RC}	Read cycle (ID)	160		ns	When read ID data
	T _{RDH}	Control pulse "H" duration (ID)	90		ns	
	T _{RDL}	Control pulse "L" duration (ID)	45		ns	
RDX (FM)	T _{RC_{FM}}	Read cycle (FM)	450		ns	When read from frame memory
	T _{RD_{HFM}}	Control pulse "H" duration (FM)	90		ns	
	T _{RD_{LFM}}	Control pulse "L" duration (FM)	355		ns	
D[17:0]	T _{DST}	Data setup time	10		ns	For CL=30pF

T_{DHT}	Data hold time	10		ns
T_{RAT}	Read access time (ID)		40	ns
T_{RATFM}	Read access time (FM)		340	ns
T_{ODH}	Output disable time	20	80	ns

Table 4 8080 Parallel Interface Characteristics

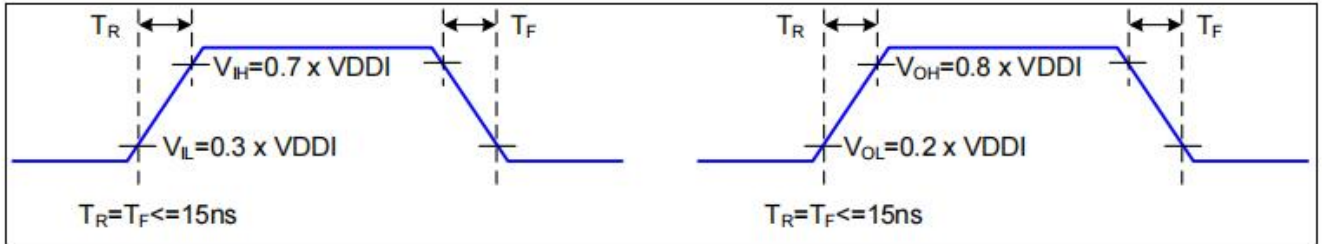


Figure 2 Rising and Falling Timing for I/O Signal

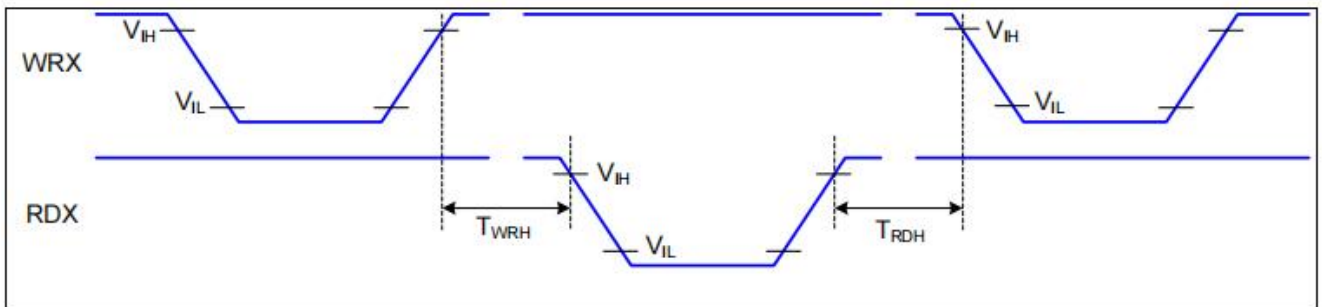


Figure 3 Write-to-Read and Read-to-Write Timing

Note: The rising time and falling time (T_r , T_f) of input signal and fall time are specified at 15 ns or less. Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

Serial Interface Characteristics (4-line serial):

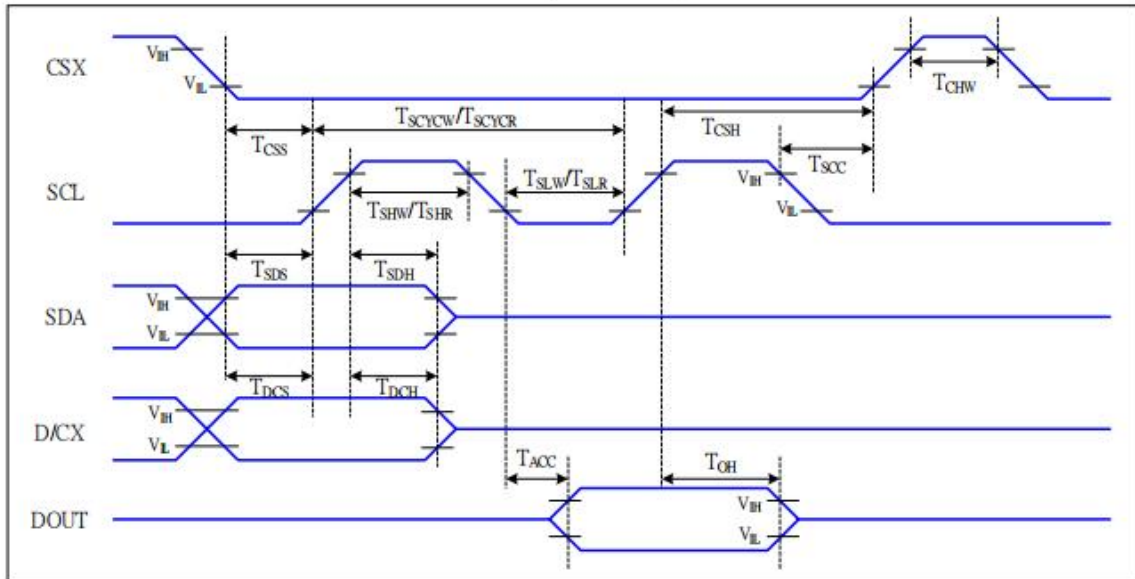


Figure 5 4-line serial Interface Timing Characteristics

V_{DDI}=1.65 to 3.3V, V_{DD}=2.4 to 3.3V, AGND=DGND=0V, T_a=25 °C

Signal	Symbol	Parameter	MIN	MAX	Unit	Description
CSX	T _{css}	Chip select setup time (write)	15		ns	
	T _{sch}	Chip select hold time (write)	15		ns	
	T _{css}	Chip select setup time (read)	60		ns	
	T _{sc}	Chip select hold time (read)	65		ns	
	T _{chw}	Chip select "H" pulse width	40		ns	
SCL	T _{scyw}	Serial clock cycle (Write)	16		ns	-write command & data ram
	T _{shw}	SCL "H" pulse width (Write)	7		ns	
	T _{slw}	SCL "L" pulse width (Write)	7		ns	
	T _{scy}	Serial clock cycle (Read)	150		ns	-read command & data ram
	T _{shr}	SCL "H" pulse width (Read)	60		ns	
	T _{slr}	SCL "L" pulse width (Read)	60		ns	
D/CX	T _{dcs}	D/CX setup time	10		ns	
	T _{dch}	D/CX hold time	10		ns	
SDA (DIN)	T _{sd}	Data setup time	7		ns	
	T _{sdh}	Data hold time	7		ns	
DOUT	T _{acc}	Access time	10	50	ns	For maximum CL=30pF
	T _{oh}	Output disable time	15	50	ns	For minimum CL=8pF

Table 6 4-line serial Interface Characteristics

Reset Timing:

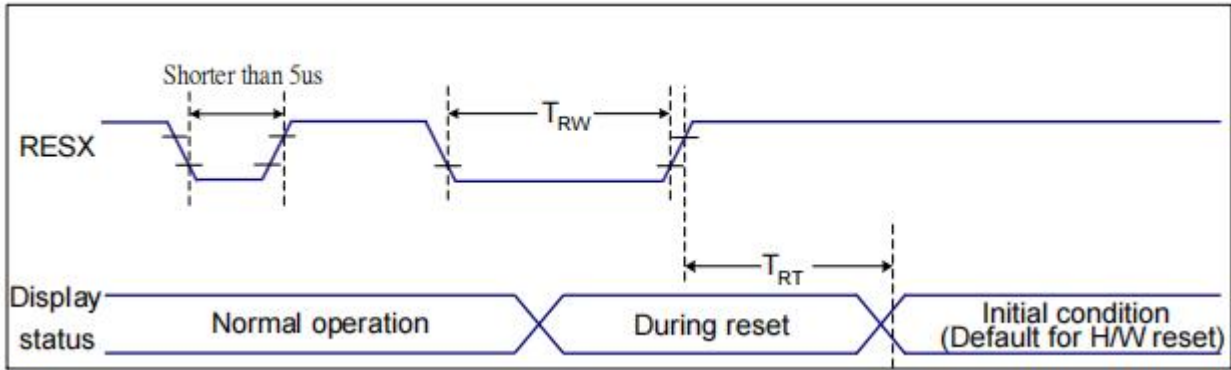


Figure 7 Reset Timing

VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta=25°C

Related Pins	Symbol	Parameter	MIN	MAX	Unit
RESX	TRW	Reset pulse duration	10	-	us
	TRT	Reset cancel	-	5 (Note 1, 5)	ms
				120 (Note 1, 6, 7)	ms

Table 9 Reset Timing

6. Optical Specifications

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	Note
Viewing Angle (CR≥10) B/L ON	θ_T	$\Phi=90^\circ$ (12 o'clock)	-	80	-	deg	Note2
	θ_B	$\Phi=270^\circ$ (6 o'clock)	-	80	-	deg	Note2
	θ_L	$\Phi=180^\circ$ (9 o'clock)	-	80	-	deg	Note2
	θ_R	$\Phi=0^\circ$ (3 o'clock)	-	80	-	deg	Note2
Response Time	T_{ON}	Normal $\theta=\Phi=0^\circ$	-	15	17	msec	Note4
	T_{OFF}		-	15	17	msec	Note4
Contrast Ratio	CR		-	1200	-	-	Note1 Note3
Color Chromaticity	W_X		TBD	TBD	TBD	-	Note1 Note5
	W_Y		TBD	TBD	TBD	-	Note1 Note5
Luminance	L		600	700	-	cd/m ²	Note1 Note7
Luminance Uniformity	Y_U		75	80	-	%	Note1 Note6
NTSC	-		60	-	-	%	-

Note 1:Definition of optical measurement system

The optical characteristics should be measured in dark room. After 5 minutes operation, the optical properties are measured at the center point of the LCD screen. All input terminals LCD panel must be ground when measuring the center area of the panel.

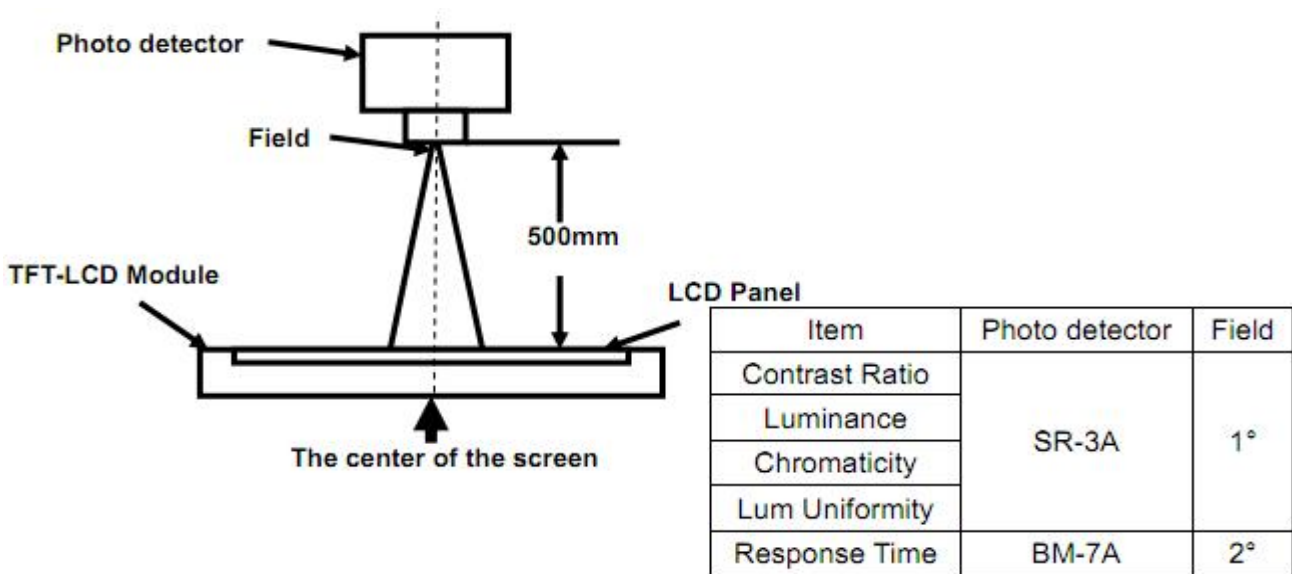


Fig 1

Note 2: Definition of viewing angle range and measurement system.

viewing angle is measured at the center point of the LCD by CONOSCOPE(ergo-80).

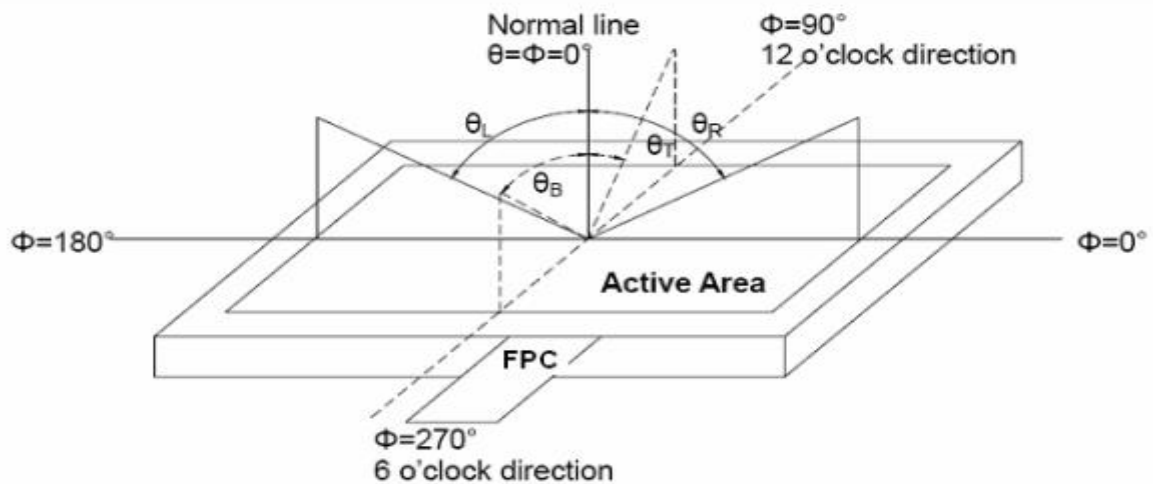


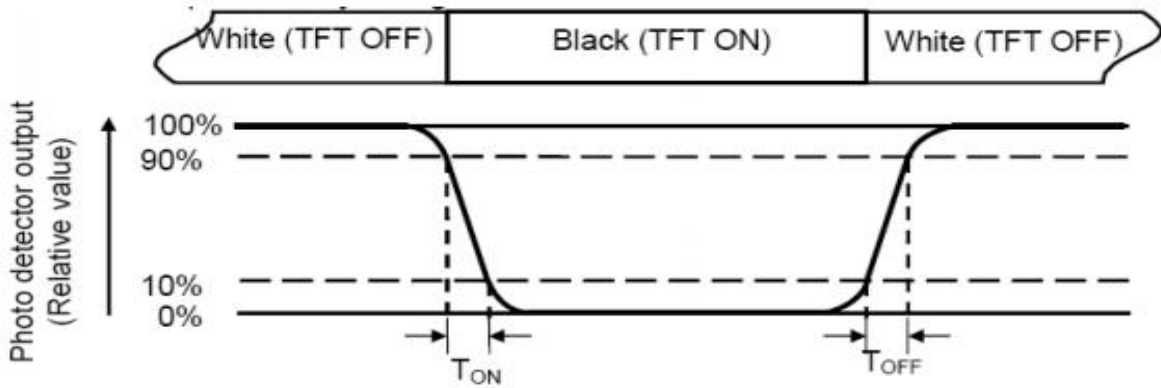
Fig 2 Definition of viewing angle

Note 3: Definition of contrast ratio

$$CR = \frac{\text{Luminance with all pixels white}}{\text{Luminance with all pixels black}}$$

Note 4: Definition of Response time

The response time is defined as the LCD optical switching time interval between “White” state and “Black” state. Rise time (TON) is the time between photo detector output intensity changed from 90% to 10%. And fall time (TOFF) is the time between photo detector output intensity changed from 10% to 90%.



Note 5: Definition of color chromaticity (CIE1931)

Color coordinates measured at center point of LCD.

Note 6: Definition of Luminance Uniformity

The luminance uniformity in surface luminance is determined by measuring luminance at each test position 1 through n, and then dividing the maximum luminance of n points luminance by minimum luminance of n points luminance. For more information see FIG.3-a/b

Note 7: Surface luminance is the luminance with all pixels displaying white.

L_v = Average Surface Luminance with all white pixels (P1, P2, P3, ..., Pn)

For more information see FIG.3-a/b

Note 8: Size : $S \leq 5"$ (see Figure a) A : 5 mm B : 5 mm. H, V : Active area

Light spot size $\varnothing = 5\text{mm}$ (BM-5) or $\varnothing = 7.7\text{mm}$ (BM-7) 50cm distance or test spot position : see Figure a.

measurement instrument : TOPCON's luminance meter SR-3A or BM-7 or compatible (see Figure 1).

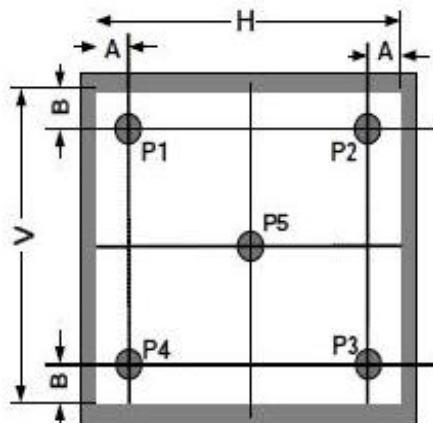


Fig. 3-a Definition of points

$5'' < S \leq 12.3''$ (see Figure b) . H,V : Active area

Light spot size $\varnothing = 5\text{mm}$ (BM-5) or $\varnothing = 7.7\text{mm}$ (BM-7) 50cm distance or compatible distance from the LCD surface to detector lens. test spot position : see Figure b.

measurement instrument : TOPCON's luminance meter SR-3A or BM-7 or compatible (see Figure 1).

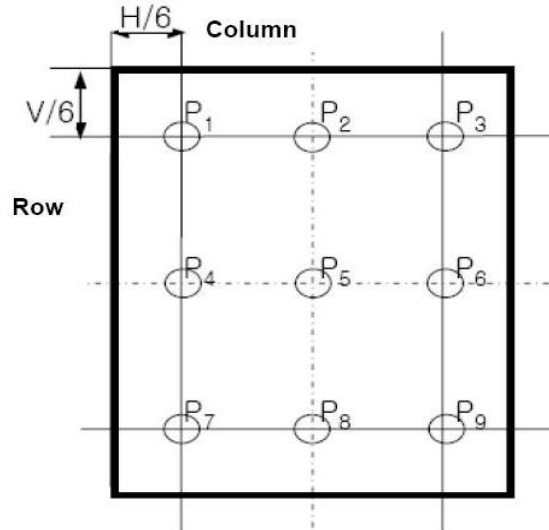


Fig. 3-b Definition of points

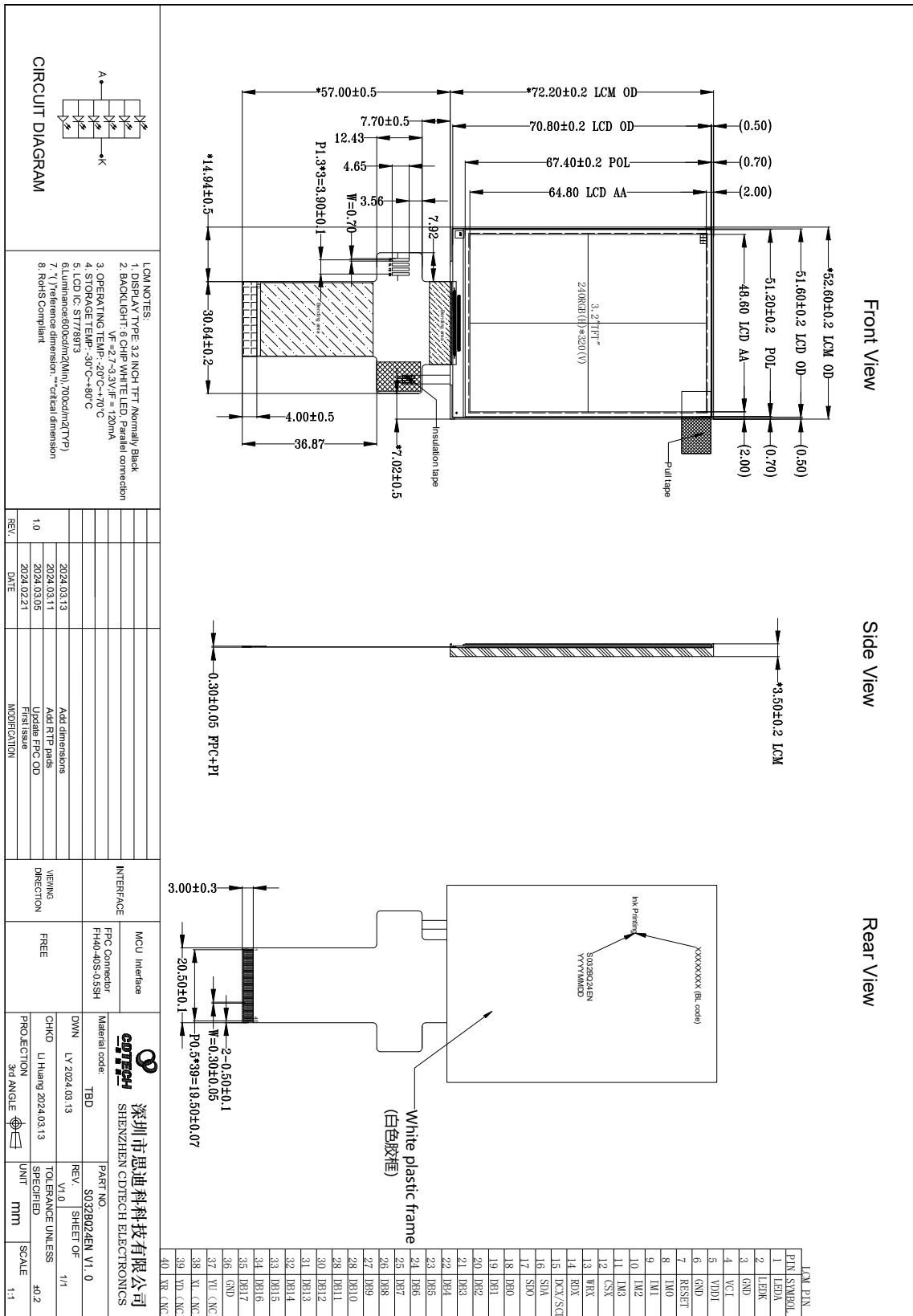
7. Reliability Test Items

Test Item	Test Conditions
High Temperature Storage	Ta= +80°C 96hrs
Low Temperature Storage	Ta= -30°C 96hrs
High Temperature Operation	Ta= +70°C 96hrs
Low Temperature Operation	Ta= -20°C 96hrs
High Temperature and Humidity Storage	Ta= +60°C, 90% RH 96hrs
Thermal Shock (Non-operation)	-30°C/30 min ~ +80°C/30 min for 20 cycles Start with cold temperature end with high temperature
Electro Static Discharge	Contact = ± 4 kV, class B Air = ± 8 kV, class B R=330Ω,C=150pF
Vibration	Sweep: 10Hz~55Hz~10Hz Stroke: 1.5mm 2 hrs for each direction of X .Y. Z.
Mechanical Shock	60G 6ms,±X,±Y,±Z 3 times for each direction
Package Drop Test	Height: 60 cm 1 corner, 3 edges, 6 surfaces

Notes: The test result shall be evaluated after the sample has been left at room temperature and humidity for 2 hours without load. No condensation shall be accepted. The sample will not be accepted if appear these defects:

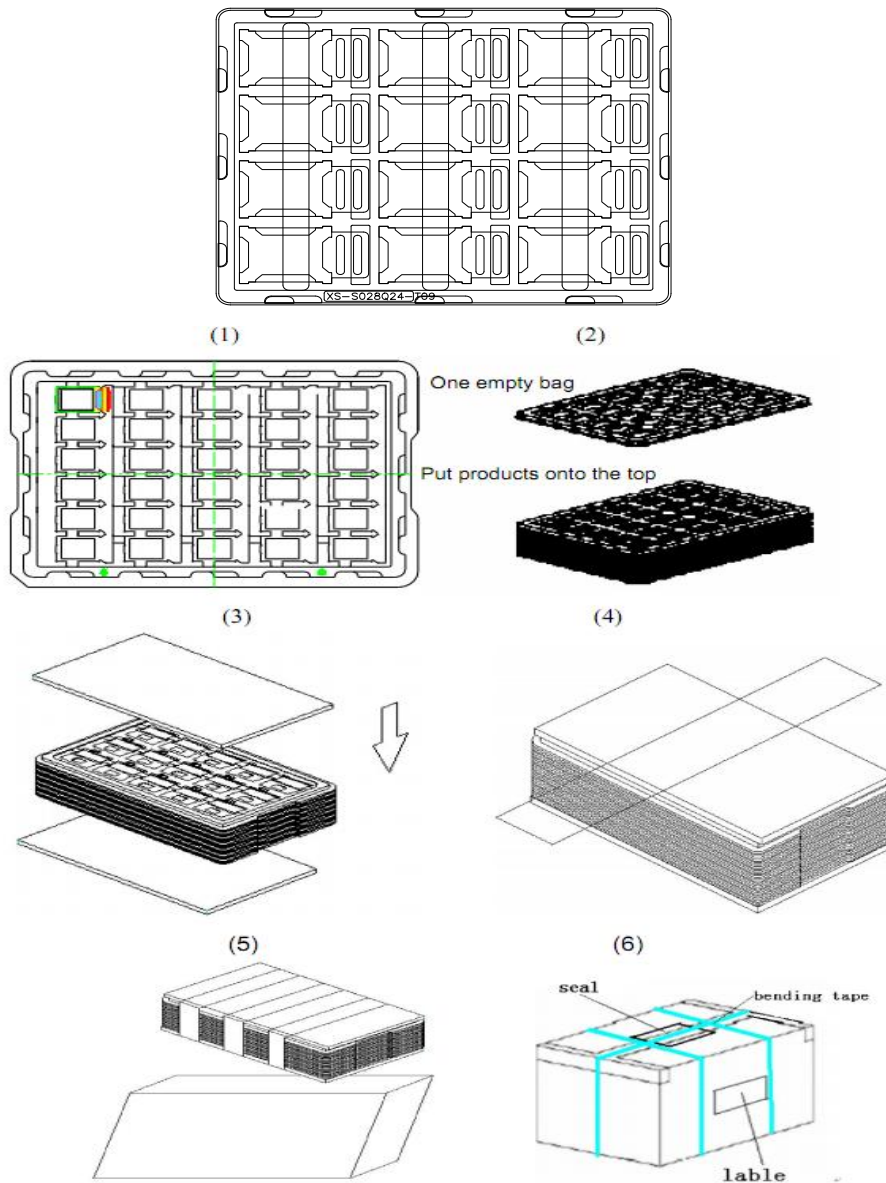
- 1). Air bubble in the LCD
- 2). Seal leak or Glass crack
- 3). Non display or abnormal display
- 4). Brightness reduction >50%

8. Mechanical Drawing



9. Packing

Packing Method



Steps:

1. Put module into tray cavity
2. Tray stacking
3. Put 1 cardboard under the tray stack and 1 cardboard above
4. Fix the cardboard to the tray stack with adhesive tape
5. Put the tray stack into carton
6. Carton sealing with adhesive tape

10. Precautions for Use of LCD modules

10.1 Handling Precautions

10.1.1. The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.

10.1.2. If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.

10.1.3. Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.

10.1.4. The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.

10.1.5. If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:

- Isopropyl alcohol
- Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketene
- Aromatic solvents

10.1.6. Do not attempt to disassemble the LCD Module.

10.1.7. If the logic circuit power is off, do not apply the input signals.

10.1.8. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.

10.1.8.1. Be sure to ground the body when handling the LCD Modules.

10.1.8.2. Tools required for assembly, such as soldering irons, must be properly ground.

10.1.8.3. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.

10.1.8.4. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

10.2 Storage Precautions

10.2.1. When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.

10.2.2. The LCD modules should be stored under the storage temperature range if the LCD modules will be stored for a long time, the recommend condition is :

Temperature : 0°C ~40°C Relatively humidity: ≤80%

10.2.3. The LCD modules should be stored in the room without acid, alkali and harmful gas.

10.3 Transportation Precautions

The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.